TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HCT374AP, TC74HCT374AF

Octal D-Type Flip-Flop with 3-State Output

The TC74HCT374A is high speed CMOS OCTAL FLIP-FLOP with 3-STATE OUTPUT fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

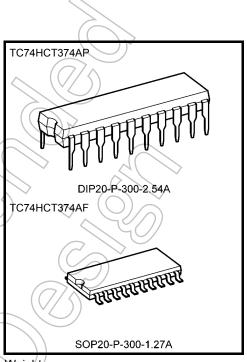
Their inputs are compatible with TTL, NMOS, and CMOS output voltage levels.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input (\overline{OE}).

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

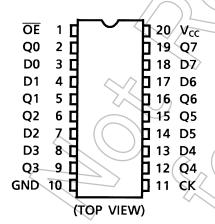
- High speed: $f_{max} = 62 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25^{\circ}C$
- Compatible with TTL outputs: V_{IH} = 2 V (min) V_{IL} = 0.8 V (max)
- Wide interfacing ability: LSTTL, NMOS, CMOS
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Pin and function compatible with 74LS374



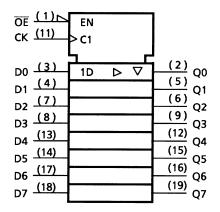
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment



IEC Logic Symbol



Truth Table

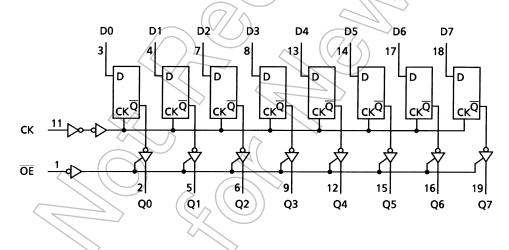
| | Output | | |
|----|---------------|---|----|
| ŌE | CK | D | Q |
| Н | Х | Х | Z |
| L | \rightarrow | Х | Qn |
| L | | L | L |
| L | | Н | Н |

X: Don't care

Z: High impedance

Qn: No change

System Diagram



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Absolute Maximum Ratings (Note 1)

| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|-------------------------------|-------|
| Supply voltage range | V _{CC} | –0.5 to 7 | V |
| DC input voltage | V _{IN} | -0.5 to V _{CC} + 0.5 | V |
| DC output voltage | V _{OUT} | -0.5 to V _{CC} + 0.5 | V |
| Input diode current | I _{IK} | ±20 | mA |
| Output diode current | lok | ±20 | mA |
| DC output current | Гоит | ±35 | mA |
| DC V _{CC} /ground current | Icc | ±75 | mA |
| Power dissipation | P _D | 500 (DIP) (Note 2)/180 (SOP) | //m/V |
| Storage temperature | T _{stg} | -65 to 150 | CC. |

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|--------------------------|---------------------------------|----------------------|------|
| Supply voltage | Vcc | 4.5 to 5.5 | V |
| Input voltage | V _{IN} | 0 to V _{CC} | V |
| Output voltage | Уоит | 0 to V _{CC} | V |
| Operating temperature | (Topr) | -40 to 85 | °C |
| Input rise and fall time | t _r , t _f | 0 to 500 | ns |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

| Characteristics | Symbol | Test Condition | | | Ta = 25°C | | | Ta = -40 to 85°C | | Unit |
|----------------------------------|------------------|---|--------------------------|---------------------|-----------|------|------|---------------------|------|----------|
| | | | | V _{CC} (V) | Min | Тур. | Max | Min | Max | |
| High-level input voltage | VIH (| · () | | 4.5 to 5.5 | 2.0 | _ | ı | 2.0 | 1 | V |
| Low-level input voltage | VIL | | | 4.5 to 5.5 | l | | 0.8 | | 0.8 | V |
| High-level output | VoH | V _{IN} = V _{IH} or V _{IL} | $I_{OH} = -20 \mu A$ | 4.5 | 4.4 | 4.5 | _ | 4.4 | _ | V |
| voltage | voltage | | $I_{OH} = -6 \text{ mA}$ | 4.5 | 4.18 | 4.31 | _ | 4.13 | | V |
| Low-level output | Low-level output | * IIN | $I_{OL} = 20 \ \mu A$ | 4.5 | _ | 0.0 | 0.1 | | 0.1 | V |
| voltage | V _{OL} | | I _{OL} = 6 mA | 4.5 | | 0.17 | 0.26 | | 0.33 | V |
| 3-state output off-state current | loz | V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND | | 5.5 | | | ±0.5 | | ±5.0 | μА |
| Input leakage current | I _{IN} | V _{IN} = V _{CC} or GND | | 5.5 | | _ | ±0.1 | | ±1.0 | μА |
| Quiescent supply | Icc | V _{IN} = V _{CC} or GND | | 5.5 | | _ | 4.0 | | 40.0 | μΑ |
| current | IC | Per input: V _{IN} = 0.5 V or 2.4 V Other input: V _{CC} or GND | | 5.5 | _ | _ | 2.0 | | 2.9 | mA |



Timing Requirements (input: $t_r = t_f = 6$ ns)

| Characteristics | Symbol Test Condition | | Ta = | | 25°C | Ta = -40 to 85°C | Unit |
|---------------------|-----------------------|---|---------------------|-------------------------|-------|------------------------|------|
| | | | V _{CC} (V) | Тур. | Limit | Limit | |
| Minimum pulse width | t _{W (H)} | | 4.5 | _ | 15 | 19 | 20 |
| (CK) | t _{W (L)} | _ | 5.5 | $\langle \cdot \rangle$ | 14 | 17 | ns |
| Minimum set-up time | | | 4.5 | 7 | 15 | 19 | |
| (Dn) | t _s | _ | 5.5 | +(| 14 | 17 | ns |
| Minimum hold time | | | 4.5 | | 0 | 0 | |
| (Dn) | t _h | _ | 5.5 | (///) | 0 | 0 | ns |
| Cleak fraguency | f | | 4.5 | | 31 | 25 | MII- |
| Clock frequency | T | _ | 5.5 |)~ | 37 | 30 | MHz |

AC Characteristics (input: $t_r = t_f = 6$ ns)

| Characteristics | Symbol Test Condition | | Ta = 25°C | | | | Ta = -40 to 85°C | | Unit | |
|------------------------|-----------------------|----------------------|--|---------------------|---------------|------|---------------------|------------|------|---------|
| | | | CL (pF) | V _{CC} (V) | Min | Тур. | Max | Min | Max | |
| Output transition time | t _{TLH} | | 50 | 4.5 | _ | 7 | 712 | \$ <u></u> | 15 | ns |
| Output transition time | t _{THL} | | 37 | 5.5 | _ | 6 | /11) | | 14 | 20 |
| | | (| 50 | 4.5 | _ | 20 | 30 | _ | 38 | |
| Propagation delay time | t_pLH | _ | 30 | 5.5 | _ | (17) | 25 | _ | 31 | ns |
| (CK-Q) | t_pHL | 40 | 150 | 4.5 | | 25 | 38 | _ | 48 | 110 |
| | | | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | 5.5 | | 22 | 33 | _ | 41 | |
| | | $((\))$ | 50 | 4.5 | | /17 | 30 | _ | 38 | |
| Output enable time | t_{pZL} | R _L =1 KΩ | | 5.5 | | 14 | 25 | _ | 31 | ns |
| Catput Griabio timo | t _{pZH} | | 150 | 4.5 | _ | 25 | 38 | _ | 48 | 110 |
| | | | 100 | 5.5 | <u>></u> — | 19 | 33 | _ | 41 | |
| Output disable time | t _{pLZ} | $R_L = 1 k\Omega$ | 50 | 4.5 | _ | 16 | 28 | _ | 35 | ns |
| Output dioable time | (t _{pHZ}) | 1/132 | (7/ | 5.5 | _ | 14 | 24 | _ | 30 | 110 |
| Maximum clock | | | 50 | 4.5 | 31 | 50 | _ | 25 | _ | MHz |
| frequency | f _{max} | | 7/2 | 5.5 | 37 | 59 | _ | 30 | _ | IVII IZ |
| Input capacitance | C _{IN} | | - | | _ | 5 | 10 | _ | 10 | pF |
| Output capacitance | Cout | | \rightarrow | | _ | 10 | 1 | _ | _ | pF |
| Power dissipation | c_{PD} | | | | | 48 | | | | pF |
| capacitance | (Note) | | | | | 70 | | | | ρı |

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

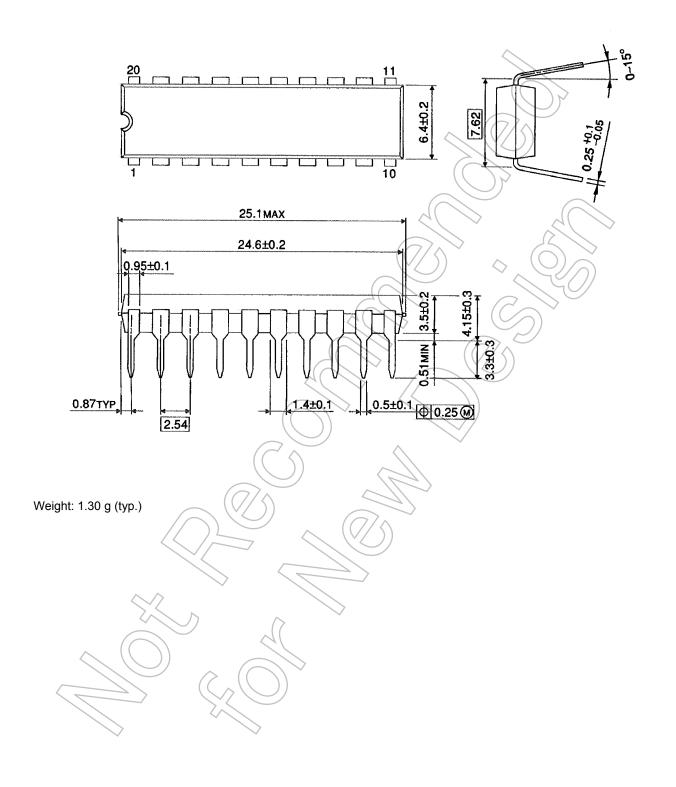
 I_{CC} (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per F/F)

And the total CPD when n pcs. of flip flop operate can be gained by the following equation:

 C_{PD} (total) = 30 + 18 · n

Package Dimensions

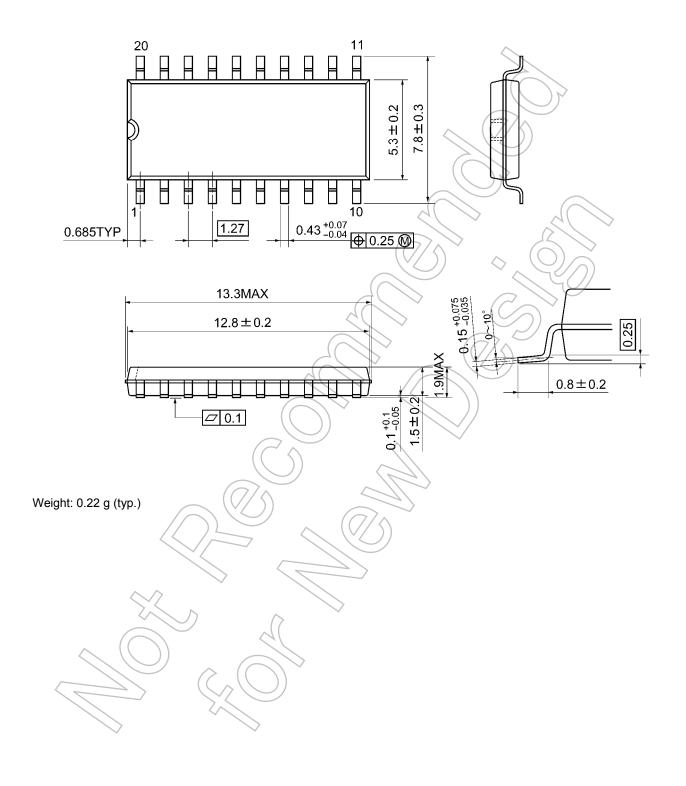
DIP20-P-300-2.54A Unit: mm





Package Dimensions

SOP20-P-300-1.27A Unit: mm



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2014-03-01